Features

- Fast Read Access Time 150 ns
- Fast Byte Write 200 µs or 1 ms
- Self-Timed Byte Write Cycle Internal Address and Data Latches Internal Control Timer
 Automatic Clear Before Write
- Direct Microprocessor Control
 DATA POLLING
- Low Power

30 mA Active Current 100 uA CMOS Standby Current

High Reliability

Endurance: 10⁴ or 10⁵ cycles
Data Retention: 10 years

- 5 V ± 10% Supply
- CMOS & TTL Compatible Inputs and Outputs
- JEDEC Approved Byte Wide Pinout
- Full Military, Commercial, and Industrial Temperature Ranges

Description

The AT28C16 is a low-power, high-performance Electrically Erasable and Programmable Read Only Memory with easy to use features. The AT28C16 is a 16K memory organized as 2,048 words x 8 bits. The device is manufactured with Atmel's reliable non-volatile CMOS technology.

The AT28C16 is accessed like a static RAM for the read or write cycles without the need of external components. During a byte write, the address and data are latched internally, freeing the microprocessor address and data bus for other operations. Following the initiation of a write cycle, the device will go to a busy state and automatically clear and write the latched data using an internal control timer. The end of a write cycle can be determined by DATA polling of I/O7. Once the end of a write cycle has been detected, a new access for a read or a write can begin.

The CMOS technology offers fast access times of 150 ns at low power dissipation. When the chip is deselected the standby current is less than $100 \mu A$.

Atmel's 28C16 has additional features to ensure high quality and manufacturability. The device utilizes error correction internally for extended endurance and for improved data retention characteristics. An extra 32 bytes of E²PROM are available for device identification or tracking.

Pin Configurations

Pin Name	Function
A0 - A10	Addresses
CE	Chip Enable
ŌĒ	Output Enable
WE	Write Enable
1/00 - 1/07	Data Inputs/Outputs
NC	No Connect

CERDIP, PDIP, SOIC Top View

PLCC
Top View

A7 NC VCC NC
NC NC WE

A6 5 28 A9
A4 7 7 27 NC
A2 9 25 OE
A4 10 24 A10
A1 10 24 A10
A10 11 23 CE
UC 12 22 UC
UCS 1 2 NC 3 4 5

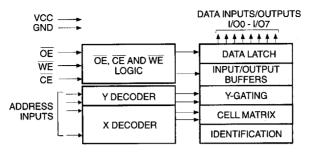
Note: PLCC package pins 1 and 17 are DON'T CONNECT.



16K (2K x 8) CMOS E²PROM



Block Diagram



Absolute Maximum Ratings*

Temperature Under Bias55°C to - Storage Temperature65°C to -	
All Input Voltages (including N.C. Pins) with Respect to Ground	⊦6.25 V
All Output Voltages with Respect to Ground0.6 V to Vcc	+0.6 V
Voltage on $\overline{\text{OE}}$ and A9 with Respect to Ground	⊦13.5 V

*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Device Operation

READ: The AT28C16 is accessed like a Static RAM. When \overline{CE} and \overline{OE} are low and \overline{WE} is high, the data stored at the memory location determined by the address pins is asserted on the outputs. The outputs are put in a high impedance state whenever \overline{CE} or \overline{OE} is high. This dual line control gives designers increased flexibility in preventing bus contention.

BYTE WRITE: Writing data into the AT28C16 is similar to writing into a Static RAM. A low pulse on the \overline{WE} or \overline{CE} input with \overline{OE} high and \overline{CE} or \overline{WE} low (respectively) initiates a byte write. The address location is latched on the last falling edge of \overline{WE} (or \overline{CE}); the new data is latched on the first rising edge. Internally, the device performs a self-clear before write. Once a byte write has been started, it will automatically time itself to completion. Once a programming operation has been initiated and for the duration of t_{WC} , a read operation will effectively be a polling operation.

FAST BYTE WRITE: The AT28C16E offers a byte write time of 200 µs maximum. This feature allows the entire device to be rewritten in 0.4 seconds.

DATA POLLING: The AT28C16 provides DATA POLLING to signal the completion of a write cycle. During a write

cycle, an attempted read of the data being written results in the complement of that data for I/O₇ (the other outputs are indeterminate). When the write cycle is finished, true data appears on all outputs.

WRITE PROTECTION: Inadvertent writes to the device are protected against in the following ways. (a) Vcc sense— if Vcc is below 3.8 V (typical) the write function is inhibited. (b) Vcc power on delay— once Vcc has reached 3.8 V the device will automatically time out 5 ms (typical) before allowing a byte write. (c) Write Inhibit— holding any one of \overline{OE} low, \overline{CE} high or \overline{WE} high inhibits byte write cycles.

CHIP CLEAR: The contents of the entire memory of the AT28C16 may be set to the high state by the CHIP CLEAR operation. By setting \overline{CE} low and \overline{OE} to 12 volts, the chip is cleared when a 10 msec low pulse is applied to \overline{WE} .

DEVICE IDENTIFICATION: An extra 32 bytes of E^2PROM memory are available to the user for device identification. By raising A9 to 12 ± 0.5 V and using address locations 7E0H to 7FFH the additional bytes may be written to or read from in the same manner as the regular memory array.

D.C. and A.C. Operating Range

		AT28C16-15	AT28C16-20	AT28C16-25
Operating Temperature (Case)	Com.	0°C - 70°C	0°C - 70°C	0°C - 70°C
	Ind.	-40°C - 85°C	-40°C - 85°C	-40°C - 85°C
	Mil.	-55°C - 125°C	-55°C - 125°C	-55°C - 125°C
Vcc Power Supply		5 V ± 10%	5 V ± 10%	5 V ± 10%

Operating Modes

Mode	CE	ŌĒ	WE	1/0
Read	V _{IL}	V _{IL}	ViH	Dout
Write ⁽²⁾	V _{IL}	ViH	VIL	DIN
Standby/Write Inhibit	ViH	X ⁽¹⁾	Х	High Z
Write Inhibit	X	Х	ViH	
Write Inhibit	X	V _i L	Х	
Output Disable	Х	ViH	Х	High Z
Chip Erase	VIL	V _H ⁽³⁾	VIL	High Z

Notes: 1. X can be V_{IL} or V_{IH}.

3. $V_H = 12.0 V \pm 0.5 V$.

D.C. Characteristics

Symbol	Parameter	Condition		Min	Max	Units
lu	Input Load Current	ViN = 0 V to Vcc + 1 V		· · · · · ·	10	μА
llo	Output Leakage Current	V _{I/O} =0V to V _{CC}			10	μА
Is _{B1}	V _{CC} Standby Current CMOS	CE = Vcc-0.3 V to Vcc + 1.0 V	/		100	μА
I _{SB2}	V _{CC} Standby Current TTL	CE = 2.0 V to Vcc + 1.0 V	Com.		2	mA
1882	VCC Standby Current 11L	CE = 2.0 V to VCC + 1.0 V	Ind., Mil.		3	mA
lcc	Vcc Active Current A.C.	<u>f = 5</u> MHz; lout = 0 mA	Com.		30	mA
	VCC Active Ourient A.C.	CE = VIL	Ind., Mil.		45	mA
VIL	Input Low Voltage				8.0	٧
ViH	Input High Voltage			2.0		٧
VoL	Output Low Voltage	loL = 2.1 mA			.4	V
Vон	Output High Voltage	loн = -400 μA	*****	2.4	778.45	V

Pin Capacitance $(f = 1 \text{ MHz}, T = 25^{\circ}\text{C})^{(1)}$

	Тур	Мах	Units	Conditions
CIN	4	6	pF	V _{IN} = 0 V
Соит	8	12	pF	Vout = 0 V

Note: 1. This parameter is characterized and is not 100% tested.



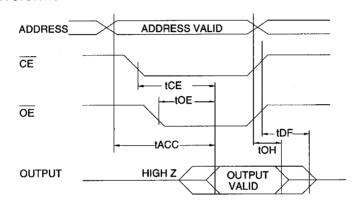
^{2.} Refer to A.C. Programming Waveforms.



A.C. Read Characteristics

Symbol		AT28C16-15		AT28C16-20		AT28C16-25		
	Parameter	Min	Max	Min	Мах	Min	Max	Units
tacc	Address to Output Delay		150		200		250	ns
tce (1)	CE to Output Delay		150		200		250	ns
toE (2)	OE to Output Delay	10	70	10	80	10	100	ns
t _{DF} (3,4)	CE or OE High to Output Float	0	50	0	55	0	60	ns
tон	Output Hold from OE, CE or Address, whichever occurred first	0		0	<u>-</u>	0		ns

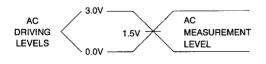
A.C. Read Waveforms (1,2,3,4)



Notes

- CE may be delayed up to t_{ACC} t_{CE} after the address transition without impact on t_{ACC}.
- OE may be delayed up to t_{CE} t_{OE} after the falling edge of CE without impact on t_{CE} or by t_{ACC} - t_{OE} after an address change without impact on t_{ACC}.
- 3. t_{DF} is specified from \overline{OE} or \overline{CE} whichever occurs first (C_L = 5 pF).
- 4. This parameter is characterized and is not 100% tested.

Input Test Waveforms and Measurement Level



 t_R , $t_F < 20$ ns

Output Test Load

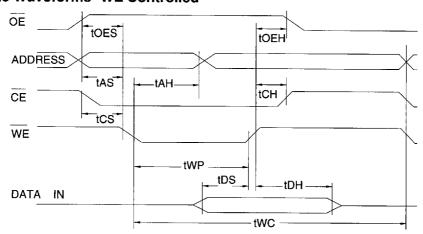


AT28C16

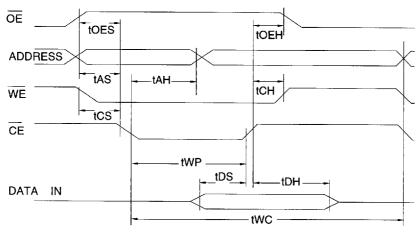
A.C. Write Characteristics

Symbol	Parameter		Min	Тур	Max	Units
tas, toes	Address, OE Set-up Time		10			ns
tah	Address Hold Time		50			пѕ
twp	Write Pulse Width (WE or CE)		100		1000	ns
tos	Data Set-up Time		50			ns
tDH,tOEH	Data, OE Hold Time		10			ns
tcs,tch	CE to WE and WE to CE Set-up a	nd Hold Time	0			ns
twc	Write Cycle Time	AT28C16		0.5	1.0	ms
IWC	write Cycle Time	AT28C16E		100	200	μs

A.C. Write Waveforms- WE Controlled



A.C. Write Waveforms- CE Controlled







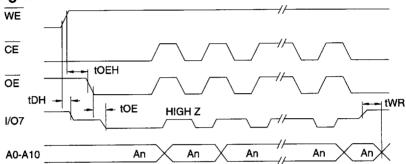
Data Polling Characteristics(1)

Symbol	Parameter	Min	Тур	Max	Units
ton	Data Hold Time	10			ns
toeh	OE Hold Time	10			ns
toE	OE to Output Delay ⁽²⁾				ns
twr	Write Recovery Time	0			ns

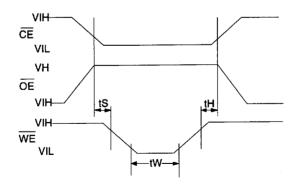
Notes: 1. These parameters are characterized and not 100% tested.

2. See A.C. Characteristics.

Data Polling Waveforms

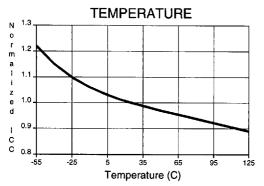


Chip Erase Waveforms

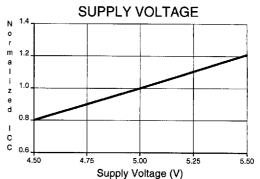


 $t_S = t_H = 1 \mu sec (min.)$ $t_W = 10 msec (min.)$ $V_H = 12.0 V \pm 0.5 V$

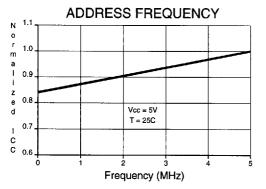
NORMALIZED SUPPLY CURRENT vs.



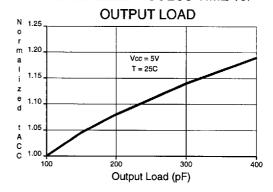
NORMALIZED SUPPLY CURRENT vs.



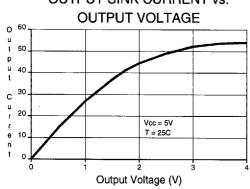
NORMALIZED SUPPLY CURRENT vs.



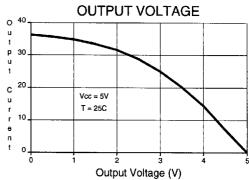
NORMALIZED ACCESS TIME vs.



OUTPUT SINK CURRENT vs.



OUTPUT SOURCE CURRENT vs.





Ordering Information⁽¹⁾

tacc	lcc	(mA)	Ordering Code	Package	Operation Range
(ns)	Active	Standby	Ordering Gode	1 donago	Operation ratings
150	30	0.1	AT28C16(E)-15DC AT28C16(E)-15JC AT28C16(E)-15PC AT28C16(E)-15SC	24D6 32J 24P6 24S	Commercial (0°C to 70°C)
150	45	0.1	AT28C16(E)-15JI AT28C16(E)-15PI AT28C16(E)-15SI	32J 24P6 24S	Industrial (-40°C to 85°C)
			AT28C16(E)-15DM/883	24D6	Military/883C Class B, Fully Compliant (-55°C to 125°C)
200	30	0.1	AT28C16(E)-20DC AT28C16(E)-20JC AT28C16(E)-20PC AT28C16(E)-20SC	24D6 32J 24P6 24S	Commercial (0°C to 70°C)
200	45	0.1	AT28C16(E)-20JI AT28C16(E)-20PI AT28C16(E)-20SI	32J 24P6 24S	Industrial (-40°C to 85°C)
			AT28C16(E)-20DM/883	24D6	Military/883C Class B, Fully Compliant (-55°C to 125°C)
250	30	0.1	AT28C16(E)-25DC AT28C16(E)-25JC AT28C16(E)-25PC AT28C16(E)-25SC AT28C16-W	24D6 32J 24P6 24S DIE	Commercial (0°C to 70°C)
250	45	0.1	AT28C16(E)-25JI AT28C16(E)-25PI AT28C16(E)-25SI	32J 24P6 24S	Industrial (-40°C to 85°C)
			AT28C16(E)-25DM/883	24D6	Military/883C Class B, Fully Compliant (-55°C to 125°C)

Note: 1. See valid Part Number table below.

Valid Part Numbers

The following table lists standard Atmel products that can be ordered.

Device Numbers	Speed	Package and Temperature Combinations	
AT28C16	15	DC, JC, JI, PC, PI, SC, SI, DM/883	
AT28C16E	15	DC, JC, JI, PC, PI, SC, SI, DM/883	
AT28C16	20	DC, JC, JI, PC, PI, SC, SI, DM/883	
AT28C16E	20	DC, JC, JI, PC, PI, SC, SI, DM/883	
AT28C16	25	DC, JC, JI, PC, PI, SC, SI, DM/883	
AT28C16E	25	DC, JC, JI, PC, PI, SC, SI, DM/883	

Ordering Information

,	Package Type	
24D6	24 Lead, 0.600" Wide, Non-Windowed, Ceramic Dual Inline Package (Cerdip)	
32J	32 Lead, Plastic J-Leaded Chip Carrier (PLCC)	
24P6	24 Lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)	
245	24 Lead, 0.300" Wide, Plastic Gull Wing Small Outline (SOIC)	
W	Die	
	Options	
Biank	Standard Device: Endurance = 10K Write Cycles; Write Time = 1 ms	
E	High Endurance Option: Endurance = 100K Write Cycles; Write Time = 200 μs	

